

Hot Stamp

SUPPLY COMPANY

TECHNICAL DATA SHEET

Series: GB01, BFD, BKR, BFR, CA26, CB26

Substrate

ABS
Acetate
Acrylic
Lacquered Wood
Polycarbonate
Coated Paper

Polystyrene
Polyurethane
Rigid PVC
Satin Ribbon
Polyester

Die Temperature Range

220-300° F Metal
104-149° C Metal
250-425° Silicone
121-218° Silicone

Carrier

16 Micron (60ga.)
Polyester Film

Series: BD68, MK68, SA68

Substrate

ABS (BD Formulation)
Acetate (BD Formulation)
PE (MK Formulation)
Lacq. Wood (BD Formulation)
Coated Paper (BD Formulation)

PVC (BD Formulation)
Acrylic (BD Formulation)
PP (SA Formulation)
Polystyrene (BD)
UV Coated Paper (SA)

Die Temperature Range

220-300° F Metal
104-149° C Metal
250-425° F Silicone
121-218° C Silicone

Carrier

16 Micron (60ga.)
Polyester Film

Series: LFQ

Substrate

Acetate Laminated Stock
Book Stock
Kromekote
Dry Paper Stock
Inked/Lacquered Stock
Lacquered Wood
Labeled Stock (Self-Ad)

Leather (Coated)
Leather (Uncoated)
Pyroxylin
Satin Ribbon
Velour Paper Stock
UV Coated

Die Temperature Range

250-350° F Metal
120-180° C Metal

Carrier

16 Micron (60ga.)
Polyester Film